

1. Description

KNX2908B, uses advanced trench technology to provide excellent $R_{DS(ON)}$, Low gate charge,It can be used in a wide variety of applications.

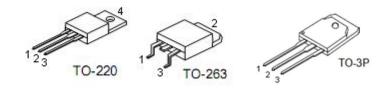
2. Features

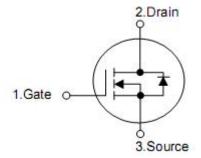
- V_{DS} =80V, I_D =130A $R_{DS(ON) (typ.)}$ =5.0m Ω @ V_{GS} =10V
- High density cell design for lower Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high EAS
- Excellent package for good heat dissipation

3. Applications

- Power switching application
- Hard switched and High frequency circuits
- Uninterruptible power supply

4.Symbol





Pin	Function	
1	Gate	
2	Drain	
3	Source	
4	Drain	



5. Ordering Information

Part Number	Package	Brand		
KNB2908B	TO-263	KIA		
KNP2908B	TO-220	KIA		
KNH2908B	TO-3P	KIA		

6. Absolute maximum ratings

Parameter	Symbo	Rating	Units
Drain-source voltage	V _{DS}	80	V
Gate-source voltage	V _{GS}	<u>+</u> 20	V
Continuous drain curren	I _D	130	Α
Pulsed drain current (Note1)	I _{DM}	520	Α
Single pulse avalanche energy ^(Note2)	E _{AS}	900	mJ
Derating Factor above 25°C	P _D	245	W/°C
Operation junction and temperature range	T _{J,}	-55 to175	°C

7. Thermal characteristics

Symbol Parameter		Max	Unit
Rejc	Thermal Resistance, Junction-to-Case	0.61	°C /W



8. Electrical characteristics

(T_A=25°C,unless otherwise noted)

$(T_A=25^{\circ}C, \text{unless otherwise noted})$							
Parameter	Symbol	Test Conditions	Min	Тур	Max	Units	
Off Characteristics							
Drain-source breakdown voltage	BV _{DSS}	V_{GS} =0 V , I_D =250 μ A	80	-	-	V	
Drain-Source Leakage Current	I _{DSS}	V _{DS} =80V, V _{GS} =0V	-	-	1	μA	
Gate-Soure Forward Leakage	I _{GSS(F)}	V _{GS} =+20V	-	-	100	nA	
Gate-Soure Reverse Leakage	I _{GSS(R)}	V _{GS} =-20V	-	-	-100	nA	
On Characteristics							
Drain-source on-Resistance ^(Note3)	R _{DS(on)}	V_{GS} =10 V , I_D =35 A	-	5.0	6.0	mΩ	
Gate threshold voltage	V _{GS(th)}	V_{DS} = V_{GS} , I_D = $250\mu A$	2.0	2.9	4.0	V	
Forward Transconductance	gfs	V_{DS} =5 V , I_D =20 A	-	42	-	S	
Dynamic Characteristics							
Total gate charge	Qg	V_{DD} =40V, V_{GS} =10V I_{D} =20A	-	160	-	nC	
Gate-source charge	Q _{gs}		-	31	-		
Gate-drain charge	Q _{gd}		-	50	-		
Turn-on delay time	t _{d(on)}	V _{DD} =30V,	-	24	-	ns	
Rise time	t _r	I_D =40A, R_{GEN} =3 Ω , V_{GS} =10V,	-	41	-		
Turn-off delay time	t _{d(off)}		-	75	-		
Fall time	t _f		-	25	-		
Switching Characteristics (Note 4)							
Input capacitance	C _{iss}	V _{DS} =25V,V _{GS} =0V, f=1MHz	-	7950	-		
Output capacitance	Coss		-	460	-	pF	
Reverse transfer capacitance	C _{rss}	1 1111112	-	380	-		
Drain-Source Diode Characteristics							
Diode Forward voltage	V _{SD}	V _{GS} =0V,I _S =20A	-	-	1.3	V	
	1						

Note

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. EAS condition :T j=25°C,VDD=50V,VG=10V,L=0.5mH,Rg=1 Ω
- 3. Pulse Test: Pulse Width $\leq 300 \mu s$, Duty Cycle $\leq 2\%$.
- 4. Guaranteed by design, not subject to production.



9. Test circuits

